

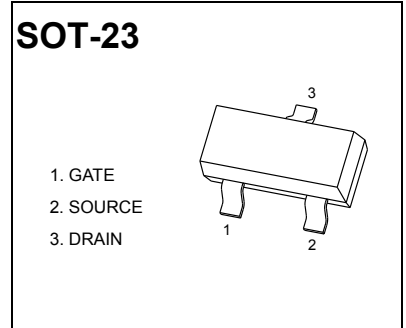
## SOT-23 Plastic-Encapsulate MOSFETS

### 30V N-Channel MOSFET

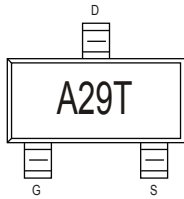
| $V_{(BR)DSS}$ | $R_{DS(on)MAX}$ | $I_D$ |
|---------------|-----------------|-------|
| 30V           | 28 mΩ@10V       | 5A    |
|               | 34 mΩ@4.5V      |       |

### Features

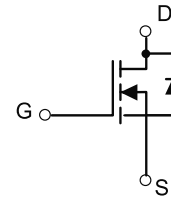
Lead free product is acquired  
Surface mount package



### MARKING



### Equivalent circuit



### PACKAGE SPECIFICATIONS

| Package | Reel Size | Reel DIA. (mm) | Q'TY/Reel (pcs) | Box Size (mm) | QTY/Box (pcs) | Carton Size (mm) | Q'TY/Carton (pcs) |
|---------|-----------|----------------|-----------------|---------------|---------------|------------------|-------------------|
| SOT-23  | 7'        | 178            | 3000            | 203×203×195   | 45000         | 438×438×220      | 180000            |

### Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

| Parameter  | Symbol          | Limit      | Unit |   |
|--|-----------------|------------|------|---|
| Drain-Source Voltage                             | $V_{DS}$        | 30         | V    |   |
| Gate-Source Voltage                              | $V_{GS}$        | ±16        |      |   |
| Continuous Drain Current                         | $I_D$           | TA=25°C    | 5.0  | A |
|  |                 | TA=70°C    | 4    |   |
| Maximum Power Dissipation <sup>2)</sup>          | $P_D$           | TA=25°C    | 1.5  | W |
|  |                 | TA=70°C    | 0.9  |   |
| Pulsed Drain Current <sup>1)</sup>               | $I_{DM}$        | 20.4       | A    |   |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$  | -50 to 150 | °C   |   |
| Thermal Resistance Junction-Ambient              | $R_{\theta JA}$ | 80         | °C/W |   |

#### Notes

- 1) Pulse width limited by maximum junction temperature.  
2) Surface Mounted on FR4 Board,  $t \leq 5$  sec.

The above data are for reference only.

## MOSFET ELECTRICAL CHARACTERISTICS

 $T_a=25\text{ }^\circ\text{C}$  unless otherwise specified

| Parameter                                      | Symbol       | Test Condition  | Min. | Typ. | Max. | Unit      |
|--|--------------|---|------|------|------|-----------|
| <b>Static</b>                                  |              |   |      |      |      |           |
| Drain-Source Breakdown Voltage                 | $BV_{DSS}$   | $V_{GS} = 0V, I_D = 250\mu A$                               | 30   |      |      | V         |
| Drain-Source On-State Resistance <sup>1)</sup> | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 4.0A$                                  |      | 28   | 36   | $m\Omega$ |
|  |              | $V_{GS} = 4.5V, I_D = 3.0A$                                 |      | 34   | 50   |           |
|  |              | $V_{GS} = 2.5V, I_D = 1.0A$                                 |      | 55   | 80   |           |
| Gate Threshold Voltage                         | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$                           | 0.5  | 0.8  | 1.2  | V         |
| Zero Gate Voltage Drain Current                | $I_{DSS}$    | $V_{DS}=30V, V_{GS}=0V$                                     |      |      | 1    | $\mu A$   |
| Gate Body Leakage                              | $I_{GSS}$    | $V_{GS}=\pm 16V, V_{DS}=0V$                                 |      |      | 100  | nA        |
| Forward Transconductance <sup>1)</sup>         | $g_{fs}$     | $V_{DS} = 15V, I_D = 4A$                                    |      | 8    | —    | S         |
| <b>Dynamic</b>                                 |              |   |      |      |      |           |
| Total Gate Charge                              | $Q_g$        | $V_{DS} = 15V, I_D = 4A$<br>$V_{GS} = 4.5V$                 |      | 3.1  |      | nC        |
| Gate-Source Charge                             | $Q_{gs}$     |   |      | 0.4  |      |           |
| Gate-Drain Charge                              | $Q_{gd}$     |   |      | 1.3  |      |           |
| Turn-On Delay Time                             | $t_{d(on)}$  | $V_{DD} = 15V, R_G=3.3\ \Omega$<br>$I_D = 1A, V_{GS} = 10V$ |      | 4.4  |      | ns        |
| Turn-On Rise Time                              | $t_r$        |   |      | 2.6  |      |           |
| Turn-Off Delay Time                            | $t_{d(off)}$ |   |      | 25.5 |      |           |
| Turn-Off Fall Time                             | $t_f$        |   |      | 3.3  |      |           |
| Input Capacitance                              | $C_{iss}$    | $V_{DS} = 15V, V_{GS} = 0V$<br>$f = 1.0\text{ MHz}$         |      | 240  |      | pF        |
| Output Capacitance                             | $C_{oss}$    |   |      | 35   |      |           |
| Reverse Transfer Capacitance                   | $C_{rss}$    |   |      | 30   |      |           |
| Source drain current(Body Diode)               | $I_{SD}$     |   |      |      | 1.8  | A         |
| Diode Forward Voltage                          | $V_{SD}$     | $I_S = 4.0A, V_{GS} = 0V$                                   |      | 0.85 | 1.2  | V         |

<sup>1)</sup> Pulse test : Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .

Typical Characteristics

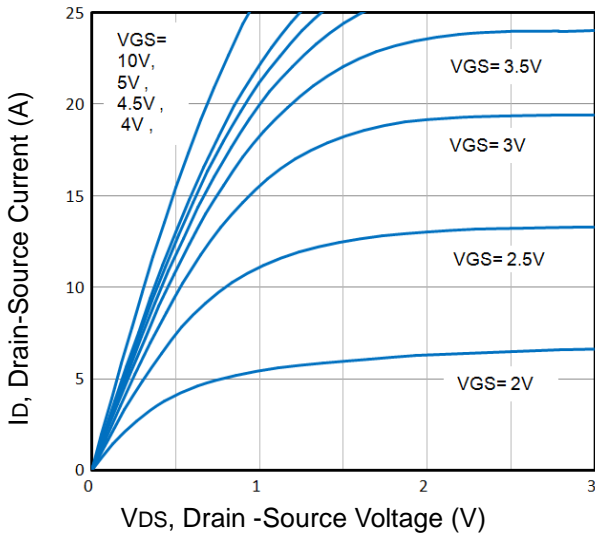


Fig1. Typical Output Characteristics

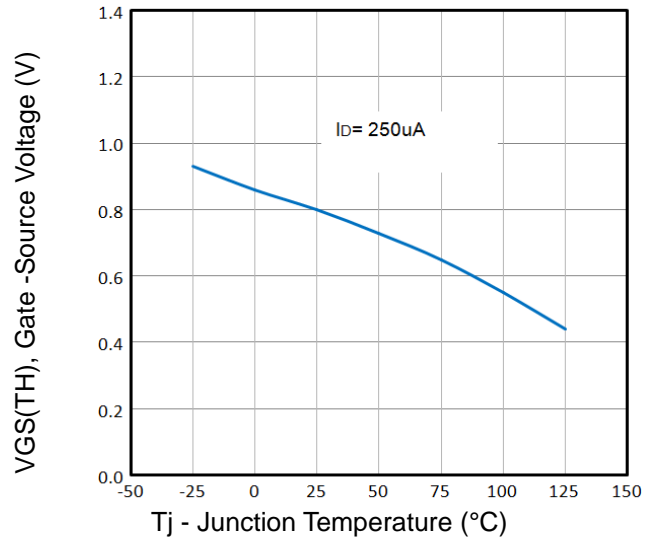


Fig2. Normalized Threshold Voltage Vs. Temperature

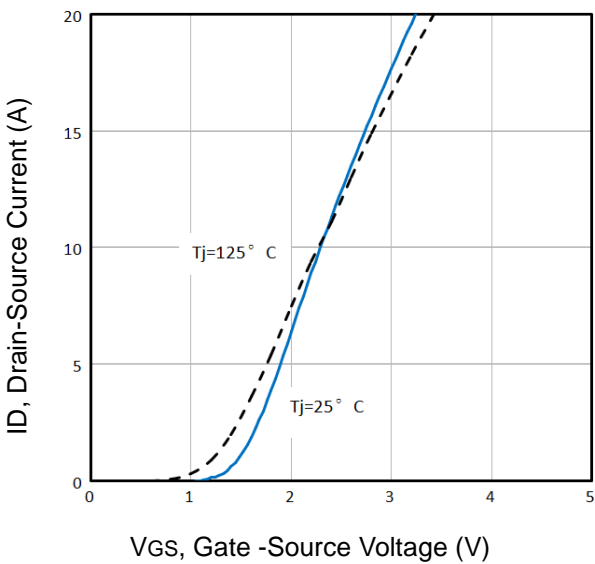


Fig3. Typical Transfer Characteristics

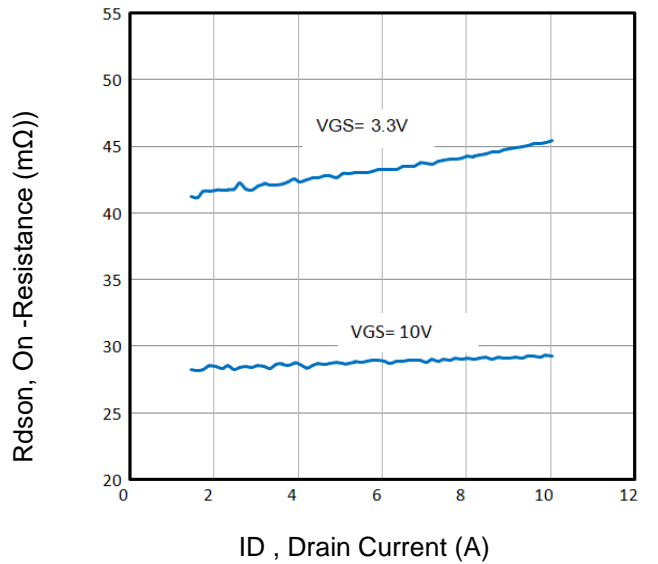


Fig4. On-Resistance vs. Drain Current and Gate

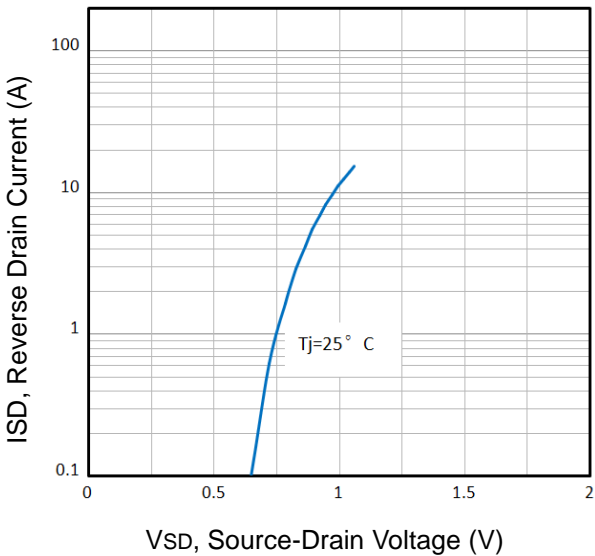


Fig5. Typical Source-Drain Diode Forward Voltage

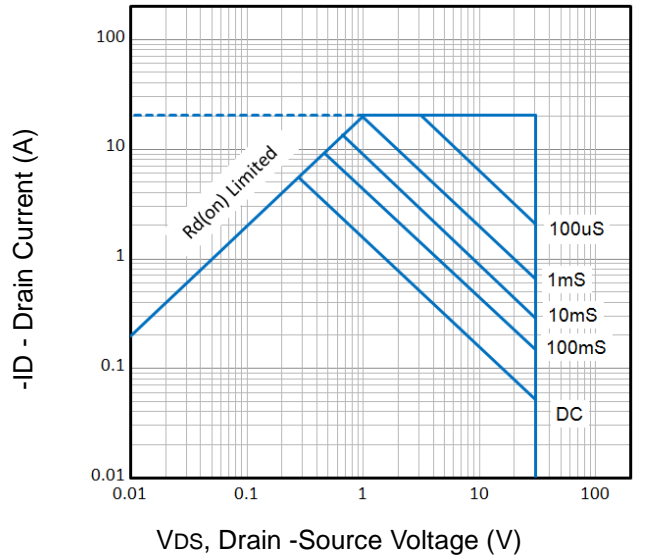


Fig6. Maximum Safe Operating Area

Typical Characteristics

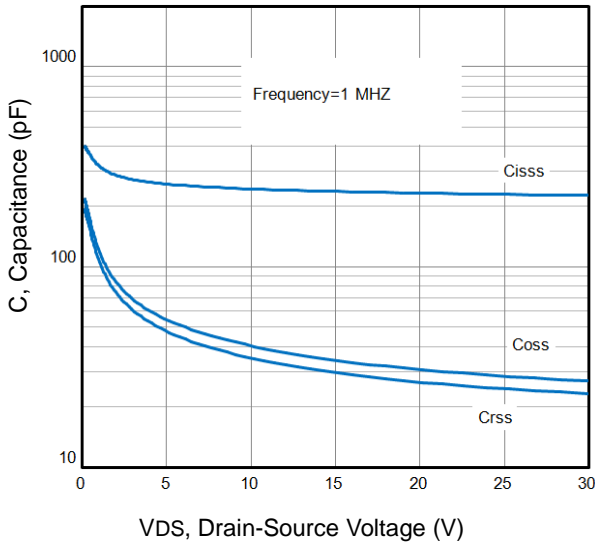


Fig7. Typical Capacitance Vs. Drain-Source Voltage

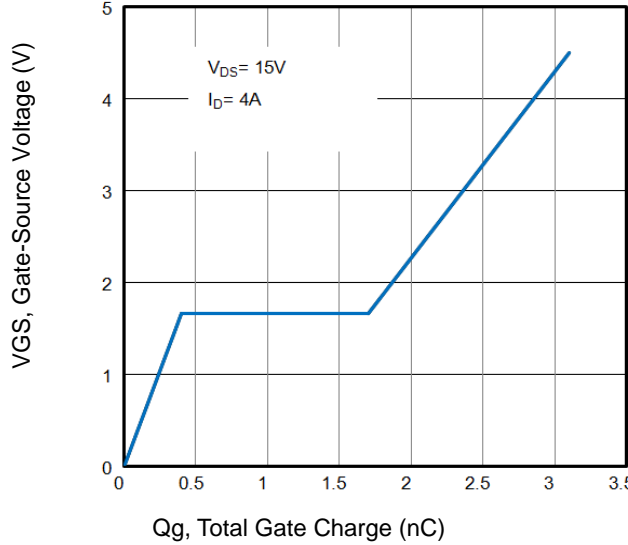


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

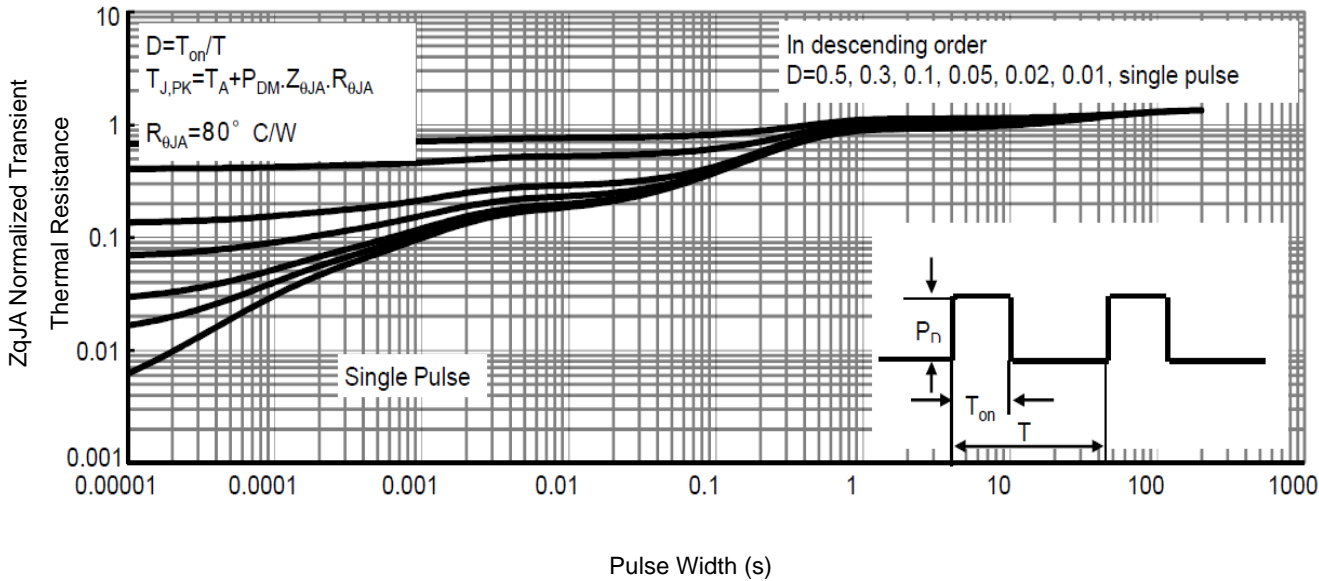


Fig9. Normalized Maximum Transient Thermal Impedance

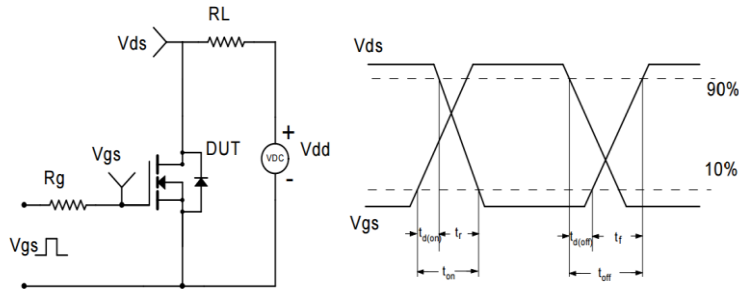
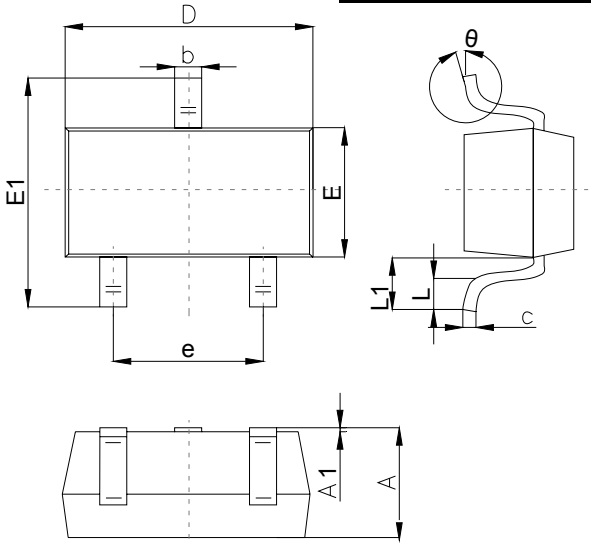


Fig10. Switching Time Test Circuit and waveforms

The curve above is for reference only.

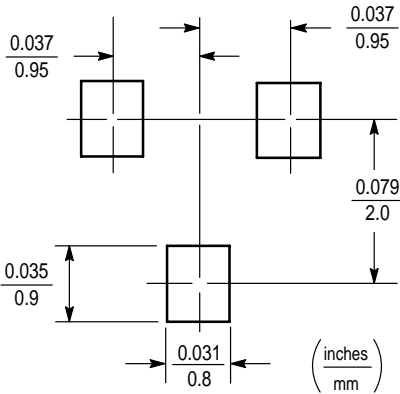
**Outlitne Drawing**

**SOT-23 Package Outline Dimensions**



| Symbol | Dimensions In Millimeters |      |      |
|--------|---------------------------|------|------|
|        | Min                       | Typ  | Max  |
| A      | 1.00                      |      | 1.40 |
| A1     |                           |      | 0.10 |
| b      | 0.35                      |      | 0.50 |
| c      | 0.10                      |      | 0.20 |
| D      | 2.70                      | 2.90 | 3.10 |
| E      | 1.40                      |      | 1.60 |
| E1     | 2.4                       |      | 2.80 |
| e      |                           | 1.90 |      |
| L      | 0.10                      |      | 0.30 |
| L1     | 0.4                       |      |      |
| θ      | 0°                        |      | 10°  |

**Suggested Pad Layout**



Note:  
 1. Controlling dimension: in/millimeters.  
 2. General tolerance:  $\pm 0.05$ mm.  
 3. The pad layout is for reference purposes only.